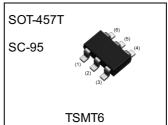


# Middle Power Transistor (-12V /-1.5A)

Parameter	Tr1 and Tr2		
V <sub>CEO</sub>	-12V		
I <sub>C</sub>	-1.5A		

## Outline



### Features

- 1) Collector current is large.
- 2) Collector saturation voltage is low  $V_{CE(sat)} \le -200 \text{mV}$  at  $I_C = -500 \text{mA} / I_B = -25 \text{mA}$

### ●Inner circuit



- (2) Tr1 Base
- (3) Tr2 Collector
- (4) Tr2 Emitter
- (5) Tr2 Base(6) Tr1 Collector
- (6) (5) (4) Tr1

  Tr2

  (1) (2) (3)

## Application

LOW FREQUENCY AMPLIFIER

### Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Quantity (pcs)	Marking
QST8	SOT-457T (TSMT6)	2928	TR	180	8	3000	T08

# ullet Absolute maximum ratings (T<sub>a</sub> = 25°C) <It is the same ratings for the Tr1 and Tr2>

Parameter	Symbol	Values	Unit
Collector-base voltage	$V_{CBO}$	-15	V
Collector-emitter voltage	$V_{CEO}$	-12	V
Emitter-base voltage	V <sub>EBO</sub>	-6	V
Calla star a umant	I <sub>C</sub>	-1.5	А
Collector current	I <sub>CP</sub> *1	-3	А
Deven discination	P <sub>D</sub> *2	0.5	W/Total
Power dissipation	P <sub>D</sub> *3*4	1.25	W/Total
Junction temperature	T <sub>j</sub>	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

# ullet Electrical characteristics (T<sub>a</sub> = 25°C) <It is the same characteristics for the Tr1 and Tr2>

Parameter	Cumbal	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Uriit	
Collector-base breakdown voltage	BV <sub>CBO</sub>	I <sub>C</sub> = -10μA	-15	-	1	V	
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = -1mA	-12	-	-	V	
Emitter-base breakdown voltage	BV <sub>EBO</sub>	I <sub>E</sub> = -10μA	-6	-	-	V	
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = -15V	-	-	-100	nA	
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = -6V	-	-	-100	nA	
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = -500mA, I <sub>B</sub> = -25mA	-	-85	-200	mV	
DC current gain	h <sub>FE</sub>	$V_{CE} = -2V, I_{C} = -200 \text{mA}$	270	-	680	-	
Transition frequency	f <sub>T</sub>	$V_{CE} = -2V, I_{E} = 200 \text{mA},$ f = 100MHz	-	400	-	MHz	
Output capacitance	C <sub>ob</sub>	V <sub>CB</sub> = -10V, I <sub>E</sub> = 0A, f = 1MHz	-	12	-	pF	

<sup>\*1</sup> Pw=1ms Single Pulse

<sup>\*2</sup> Each terminal mounted on a reference land.

<sup>\*3</sup> Mounted on a ceramic board(25×25×0.8mm).

<sup>\*4 900</sup>mW per element must not be exceeded.

# ● Electrical characteristic curves (T<sub>a</sub> = 25°C)

<For Tr1 and Tr2 in common>

Fig.1 Grounded emitter propagation characteristics

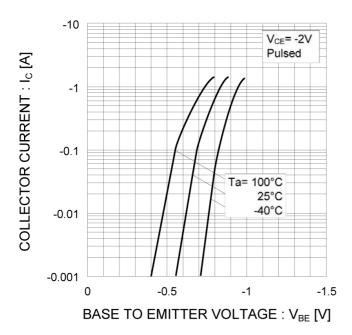
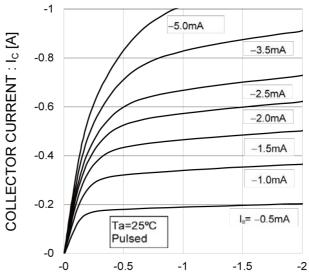


Fig.2 Typical outpur characteristics



COLLECTOR TO EMITTER VOLTAGE: V<sub>CE</sub> [V]

Fig.3 DC current gain vs. collector current (I)

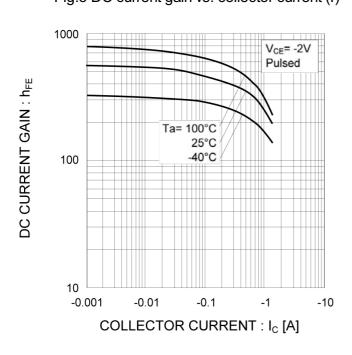
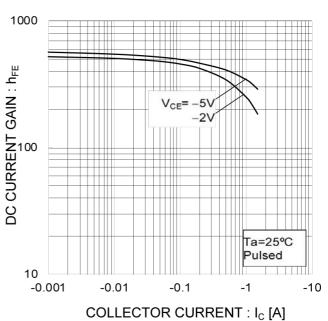


Fig.4 DC current gain vs. collector current (II)



## ● Electrical characteristic curves (T<sub>a</sub> = 25°C)

<For Tr1 and Tr2 in common>

Fig.5 Collector-emitter saturation voltage vs. collector current (I)

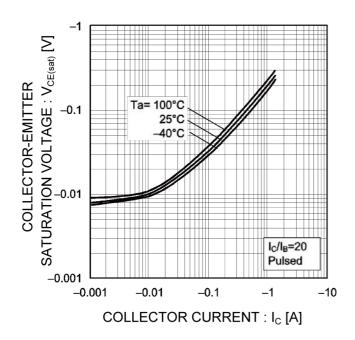


Fig.6 Collector-emitter saturation voltage vs. collector current (II)

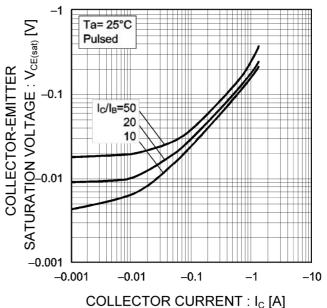


Fig.7 Base-emitter saturation voltage vs. collector current

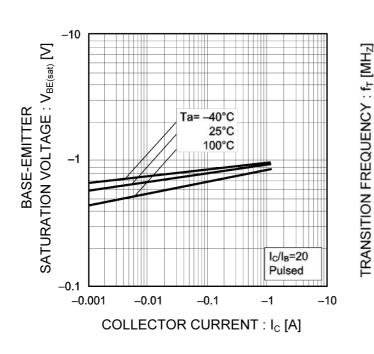
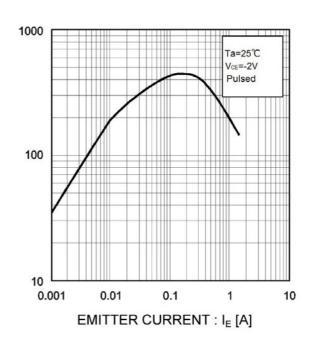


Fig.8 Gain bandwidth product vs. emitter current

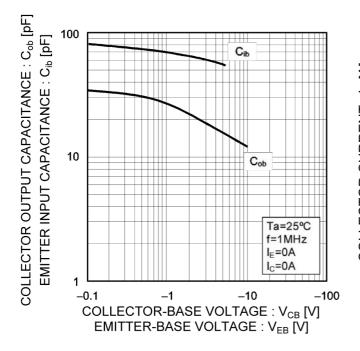


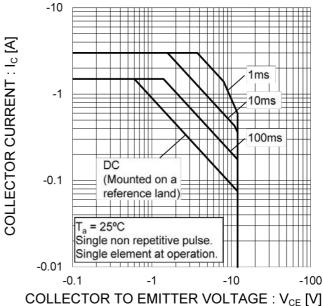
## ● Electrical characteristic curves (T<sub>a</sub> =25°C)

<For Tr1 and Tr2 in common>

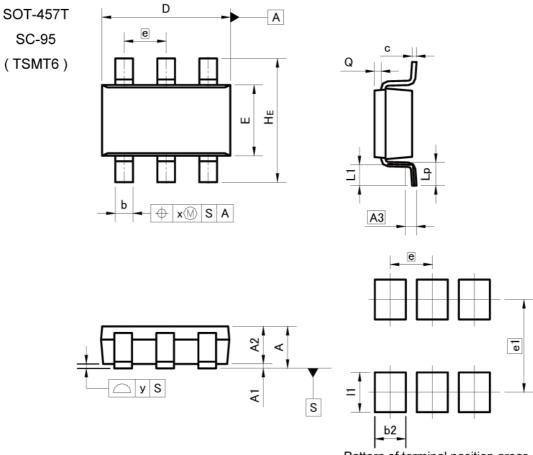
Fig.9 Emitter input capacitance vs.
emitter-base voltage
Collector output capacitance vs.
collector-base voltage

Fig.10 Safe Operating Area





## Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	# <del>=</del>	1.00	=	0.039
A1	0.00	0.10	0.000	0.004
A2	0.75	0.95	0.030	0.037
A3	0.	25	0.0	10
b	0.35	0.50	0.014	0.020
С	0.10	0.26	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.	95	0.0	37
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.05	0.25	0.002	0.010
х	10.77	0.20	=	0.008
У	<del>(;;</del>	0.10	-	0.004

DIM	MILIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
b2		0.70	-	0.028
e1	2.10		0.0	083
11	9. <del></del>	0.90		0.035

Dimension in mm/inches



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  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
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